

ABSTRACT

The present invention is aimed at providing a multilayer film having high quality and high processability which can be safely and stably produced.

Such object of the present invention can be achieved by a multilayer film comprising a base material, a polymer resin layer and a metal deposited layer and/or a metal oxide deposited layer provided thereon, wherein the polymer resin layer contains a polymer produced by polymerization of an unsaturated compound having two or more ethylenic bonds and/or acetylenic bonds in one molecule and having neither acrylic group nor methacrylic group, in an amount of 80 % by weight or more based on the polymer resin layer.

The multilayer film according to the present invention can be used for a metallized packaging film having gas barrier properties or a metallized film for a capacitor and the like.

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